Low-power configurable multiple function gate Rev. 6 — 15 August 2012 P

Product data sheet

General description 1.

The 74AUP1G58 provides configurable multiple functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions AND, OR, NAND, NOR, XOR, inverter and buffer. All inputs can be connected to V_{CC} or GND.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74AUP1G58 has Schmitt trigger inputs making it capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H.

Features and benefits 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power configurable multiple function gate

3. Ordering information

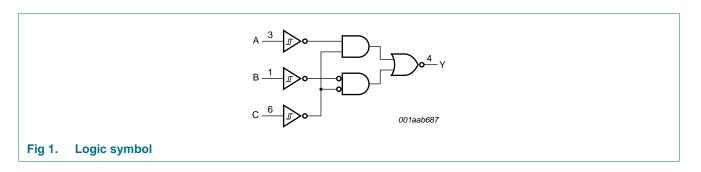
| Table 1. Ordering | g information | | | | | | | | |
|-------------------|------------------------|-------|---|---------|--|--|--|--|--|
| Type number | Package | | | | | | | | |
| | Temperature range Name | | Description | Version | | | | | |
| 74AUP1G58GW | –40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | | | | | |
| 74AUP1G58GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 | | | | | |
| 74AUP1G58GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm | SOT891 | | | | | |
| 74AUP1G58GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 | | | | | |
| 74AUP1G58GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm | SOT1202 | | | | | |

4. Marking

| Table 2. Marking | |
|------------------|-----------------------------|
| Type number | Marking code ^[1] |
| 74AUP1G58GW | аК |
| 74AUP1G58GM | аК |
| 74AUP1G58GF | аК |
| 74AUP1G58GN | аК |
| 74AUP1G58GS | аК |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

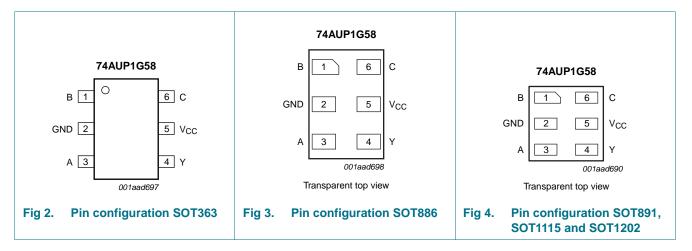
5. Functional diagram



Low-power configurable multiple function gate

6. Pinning information

6.1 Pinning



6.2 Pin description

| Table 3. | Pin description | |
|-----------------|-----------------|----------------|
| Symbol | Pin | Description |
| В | 1 | data input |
| GND | 2 | ground (0 V) |
| A | 3 | data input |
| Y | 4 | data output |
| V _{CC} | 5 | supply voltage |
| С | 6 | data input |

7. Functional description

| Table 4. | Function table ^[1] | | | |
|----------|-------------------------------|---|--------|--|
| Input | | | Output | |
| С | В | Α | Y | |
| L | L | L | L | |
| L | L | Н | Н | |
| L | Н | L | L | |
| L | Н | Н | Н | |
| Н | L | L | Н | |
| Н | L | Н | Н | |
| Н | Н | L | L | |
| Н | Н | Н | L | |

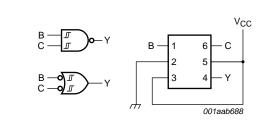
[1] H = HIGH voltage level; L = LOW voltage level.

Low-power configurable multiple function gate

7.1 Logic configurations

Table 5.Function selection table

| Logic function | Figure |
|--|---|
| 2-input NAND | see <u>Figure 5</u> |
| 2-input NAND with both inputs inverted | see Figure 8 |
| 2-input AND with inverted input | see <u>Figure 6</u> and <u>Figure 7</u> |
| 2-input NOR with inverted input | see Figure 6 and Figure 7 |
| 2-input OR | see Figure 8 |
| 2-input OR with both inputs inverted | see Figure 5 |
| 2-input XOR | see Figure 9 |
| Buffer | see Figure 10 |
| Inverter | see Figure 11 |



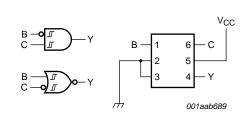


Fig 5. 2-input NAND gate or 2-input OR with both inputs inverted

Fig 6.2-input AND gate with inverted B input or
2-input NOR gate with inverted C input

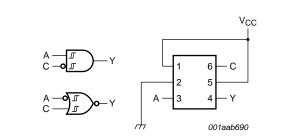


Fig 7. 2-input AND gate with inverted C input or 2-input NOR gate with inverted A input

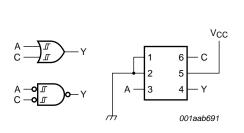
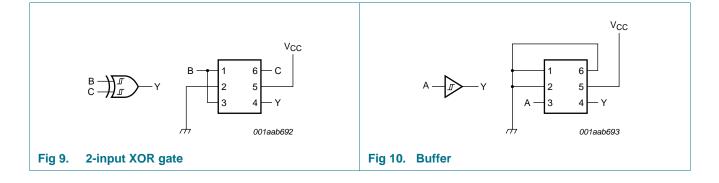
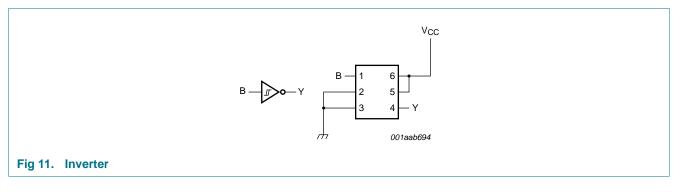


Fig 8. 2-input OR gate or 2-input NAND gate with both inputs inverted



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Limiting values 8.

Table 6. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +4.6 | V |
| Ι _{ΟΚ} | output clamping current | V _O < 0 V | -50 | - | mA |
| Vo | output voltage | Active mode and Power-down mode | <u>[1]</u> –0.5 | +4.6 | V |
| I _O | output current | $V_{O} = 0 V$ to V_{CC} | - | ±20 | mA |
| I _{CC} | supply current | | - | 50 | mA |
| I _{GND} | ground current | | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ | [2] _ | 250 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

Recommended operating conditions 9.

| Table 7. | Recommended operating co | onditions | | | |
|------------------|--------------------------|---------------------------------|-----|----------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | supply voltage | | 0.8 | 3.6 | V |
| VI | input voltage | | 0 | 3.6 | V |
| Vo | output voltage | Active mode | 0 | V_{CC} | V |
| | | Power-down mode; $V_{CC} = 0 V$ | 0 | 3.6 | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |

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10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
|--|--------------------------------------|--|---------------------|-----|---|-------------|
| T _{amb} = 2 | 5 °C | | | | | |
| V _{OH} | HIGH-level output voltage | $V_{I} = V_{T+} \text{ or } V_{T-}$ | | | | |
| | | I_O = –20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.75\times V_{CC}$ | - | - - - - - - - - - - - - - - - - - - - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.11 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.32 | - | - | V |
| | | I_{O} = -2.3 mA; V_{CC} = 2.3 V | 2.05 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.72 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.6 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{T+} \text{ or } V_{T-}$ | | | | |
| | | I_{O} = 20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.3\times V_{\text{CC}}$ | V |
| | | I_{O} = 1.7 mA; V_{CC} = 1.4 V | - | - | 0.31 | V |
| | | $ \begin{split} I_{O} &= 1.9 \text{ mA}; \ V_{CC} &= 1.65 \text{ V} & - & - & 0.31 & \text{V} \\ I_{O} &= 2.3 \text{ mA}; \ V_{CC} &= 2.3 \text{ V} & - & - & 0.31 & \text{V} \\ I_{O} &= 3.1 \text{ mA}; \ V_{CC} &= 2.3 \text{ V} & - & - & 0.44 & \text{V} \\ I_{O} &= 2.7 \text{ mA}; \ V_{CC} &= 3.0 \text{ V} & - & - & 0.31 & \text{V} \\ I_{O} &= 4.0 \text{ mA}; \ V_{CC} &= 3.0 \text{ V} & - & - & 0.44 & \text{V} \\ \end{split} $ | V | | | |
| | | I_{O} = 2.3 mA; V_{CC} = 2.3 V | - | - | 0.31 | V |
| | | I_{O} = 3.1 mA; V_{CC} = 2.3 V | - | - | 0.44 | V |
| | | I_{O} = 2.7 mA; V_{CC} = 3.0 V | - | - | 0.31 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 3.0 V | - | - | 0.44 | V |
| l _l | input leakage current | V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V | - | - | ±0.1 | μΑ |
| I _{OFF} | power-off leakage current | V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V | - | - | ±0.2 | μA |
| ΔI_{OFF} | additional power-off leakage current | $ V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; $ | - | - | ±0.2 | μΑ |
| сс | supply current | $V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | - | - | 0.5 | μΑ |
| ∆l _{CC} | additional supply current | $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | - | - | 40 | μA |
| Cı | input capacitance | V_{I} = GND or V_{CC} ; V_{CC} = 0 V to 3.6 V | - | 1.1 | - | pF |
| Co | output capacitance | $V_0 = GND; V_{CC} = 0 V$ | - | 1.8 | - | pF |
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| $\begin{tabular}{ c c c c } \hline \mathbf{V}_{OH} & HiGH-level output voltage} $$V_1 = V_{T_+} \mbox{ or } V_{T}$$ \\ \hline V_{OH} & HiGH-level output voltage} $$V_1 = V_{T_+} \mbox{ or } V_{T}$$ \\ \hline $I_0 = -20 \ \mu A; \ V_{CC} = 0.8 \ V \ 0.3.6 \ V$ $V_{CC} - 0.1 $$-$$ \\ \hline $I_0 = -1.1 \ mA; \ V_{CC} = 1.1 \ V$ $0.75 \times V_{CC} $$-$$ \\ \hline $I_0 = -1.1 \ mA; \ V_{CC} = 1.65 \ V$ $1.32 $$-$$ \\ \hline $I_0 = -2.3 \ mA; \ V_{CC} = 2.3 \ V$ $2.05 $$-$$ \\ \hline $I_0 = -2.3 \ mA; \ V_{CC} = 2.3 \ V$ $1.9 $$-$$ \\ \hline $I_0 = -2.7 \ mA; \ V_{CC} = 2.3 \ V$ $1.9 $$-$$ \\ \hline $I_0 = -2.7 \ mA; \ V_{CC} = 2.3 \ V$ $1.9 $$-$$ \\ \hline $I_0 = -2.7 \ mA; \ V_{CC} = 3.0 \ V$ $2.72 $$-$$ \\ \hline $I_0 = -4.0 \ mA; \ V_{CC} = 3.0 \ V$ $2.72 $$-$$ \\ \hline $I_0 = -4.0 \ mA; \ V_{CC} = 3.0 \ V$ $2.72 $$-$$ \\ \hline $I_0 = -4.0 \ mA; \ V_{CC} = 3.0 \ V$ $2.6 $$-$$ \\ \hline V_{OL} $$ LOW-level output voltage $$ V_1 = V_{T_1} \ V_1 = V_{T_1} $ | | | | | | |
| | | I_{O} = -20 μ A; V_{CC} = 0.8 V to 3.6 V | $V_{CC} - 0.1$ | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.7 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.03 | - | - | V |
| | | $I_0 = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.30 | - | - | V |
| | | $I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.97 | - | - | V |
| | | $I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.85 | - | - | V |
| | | | 2.67 | - | - | V |
| | | | 2.55 | - | - | V |
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| Product d | ata shoot | Rev. 6 — 15 August 2012 | | | | 6 of 2 |

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74AUP1G58

Low-power configurable multiple function gate

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--|---|---------------------|-----|---|------|
| V _{OL} | LOW-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | |
| | | I_{O} = 20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.3\times V_{CC}$ | V |
| | | I_{O} = 1.7 mA; V_{CC} = 1.4 V | - | - | 0.37 | V |
| | | $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.35 | V |
| | | $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.33 | V |
| | | $\begin{split} = & V_{T+} \text{ or } V_{T-} \\ & I_0 = 20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V & - & 0.1 \ V \\ & I_0 = 1.1 \ \text{mA}; \ V_{CC} = 1.1 \ V & - & 0.3 \times V_{CC} \ V \\ & I_0 = 1.7 \ \text{mA}; \ V_{CC} = 1.4 \ V & - & - & 0.37 \ V \\ & I_0 = 1.9 \ \text{mA}; \ V_{CC} = 1.65 \ V & - & - & 0.33 \ V \\ & I_0 = 2.3 \ \text{mA}; \ V_{CC} = 2.3 \ V & - & - & 0.33 \ V \\ & I_0 = 3.1 \ \text{mA}; \ V_{CC} = 2.3 \ V & - & - & 0.45 \ V \\ & I_0 = 2.7 \ \text{mA}; \ V_{CC} = 3.0 \ V & - & - & 0.45 \ V \\ & I_0 = 4.0 \ \text{mA}; \ V_{CC} = 3.0 \ V & - & - & 0.45 \ V \\ & I_0 = 4.0 \ \text{mA}; \ V_{CC} = 3.0 \ V & - & - & 0.45 \ V \\ & I_0 = 6 \ \text{ND} \ \text{to } 3.6 \ V; \ V_{CC} = 0 \ V \ to \ 3.6 \ V & - & - & 0.45 \ V \\ & I_0 = 6 \ \text{ND} \ \text{to } 3.6 \ V; \ V_{CC} = 0 \ V \ to \ 3.6 \ V & - & - & 0.45 \ W \\ & I_0 = V_{0} = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.45 \ W \\ & I_0 = V_{0} = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.45 \ W \\ & I_0 = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.45 \ W \\ & I_0 = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.45 \ W \\ & I_0 = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.45 \ W \\ & I_0 = 0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & 0.9 \ W \\ & I_0 = -0 \ V \ to \ 3.6 \ V; \ V_{CC} = 0 \ V & - & - & - \ V \\ & I_0 = -1.1 \ \text{mA}; \ V_{CC} = 1.4 \ V & 0.93 \ - & - \ V \\ & I_0 = -1.7 \ \text{mA}; \ V_{CC} = 1.6 \ V \ 1.17 \ - & V \\ & I_0 = -1.9 \ \text{mA}; \ V_{CC} = 1.6 \ V \ 1.177 \ - & - \ V \\ & I_0 = -1.9 \ \text{mA}; \ V_{CC} = 2.3 \ V \ 1.177 \ - & - \ V \\ & I_0 = -2.3 \ \text{mA}; \ V_{CC} = 2.3 \ V \ 1.677 \ - & V \\ & I_0 = -2.7 \ \text{mA}; \ V_{CC} = 3.0 \ V \ 2.40 \ - & - \ V \\ & I_0 = -4.0 \ \text{mA}; \ V_{CC} = 3.0 \ V \ 2.300 \ - & - \ V \\ & V_1 \ V_1$ | | | | |
| | | I_{O} = 2.7 mA; V_{CC} = 3.0 V | - | - | 0.33 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 3.0 V | - | - | 0.1 $0.3 \times V_{CC}$ 0.37 0.37 0.35 0.33 0.45 0.33 0.45 0.33 0.45 1.12 ± 0.5 1.12 ± 0.6 0.9 $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.9$ $ 0.11$ $0.33 \times V_{CC}$ 0.41 0.39 0.36 0.50 0.36 0.50 0.50 | V |
| l | input leakage current | $\label{eq:product} \begin{tabular}{ c c c c } V_1 = V_{T_*} or V_T & 0.1 & V \\ \hline l_0 = 1.1 \; mA; \; V_{CC} = 1.1 \; V & - & 0.3 \times V_{CC} & V \\ \hline l_0 = 1.7 \; mA; \; V_{CC} = 1.4 \; V & - & 0.37 & V \\ \hline l_0 = 1.7 \; mA; \; V_{CC} = 1.4 \; V & - & 0.33 & V \\ \hline l_0 = 1.7 \; mA; \; V_{CC} = 2.3 \; V & - & 0.33 & V \\ \hline l_0 = 2.3 \; mA; \; V_{CC} = 2.3 \; V & - & 0.45 & V \\ \hline l_0 = 2.7 \; mA; \; V_{CC} = 3.0 \; V & - & 0.45 & V \\ \hline l_0 = 2.7 \; mA; \; V_{CC} = 3.0 \; V & - & 0.45 & V \\ \hline l_0 = 4.0 \; mA; \; V_{CC} = 0 \; V \; to 3.6 \; V & - & 0.45 & V \\ elaskage current & V_1 = OV \; Do 3.6 \; V; \; V_{CC} = 0 \; V \; to 3.6 \; V & - & 0.45 & V \\ \hline l_0 = 2.7 \; mA; \; V_{CC} = 0 \; V \; to 3.6 \; V & - & 0.45 & V \\ \hline l_0 = 2.7 \; mA; \; V_{CC} = 0 \; V \; to 3.6 \; V & - & 0.45 & V \\ \hline l_0 = 4.0 \; mA; \; V_{CC} = 0 \; V \; to 3.6 \; V & - & 0.45 & V \\ \hline l_0 = 0 \; V \; D \; 0 \; 0 \; V \; to 3.6 \; V; \; V_{CC} = 0 \; V \\ \hline l_0 = 0 \; V \; V_0 = 0 \; V \; to 3.6 \; V; \; V_{CC} = 0 \; V \\ \hline l_0 = 0 \; V \; V_0 = 0 \; V \; to 3.6 \; V; \; V_{CC} = 0 \; V \\ \hline l_0 = 0 \; V \; V_0 = 0 \; V \; to 3.6 \; V; \; V_{CC} = 0 \; V \\ \hline l_0 = 0 \; V \; V_0 = 0 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.1 \; U \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline V_{CC} = 0.1 \; U \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -1.7 \; mA; \; V_{CC} = 1.6 \; V \; 1.17 \; V \\ \hline l_0 = -1.7 \; mA; \; V_{CC} = 1.6 \; V \; 1.17 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \; V \\ \hline l_0 = -1.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \\ \hline l_0 = -2.7 \; mA; \; V_{CC} = 0.8 \; V \; to 3.6 \; V \; V \\ \hline l_0 = -2.7 \; mA; \; V_$ | | | | |
| I _{OFF} | power-off leakage current | $V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$ | - | - | ±0.5 | μA |
| ΔI_{OFF} | additional power-off leakage current | | - | - | ±0.6 | μA |
| I _{CC} | supply current | | - | - | 0.9 | μA |
| Δl _{CC} | additional supply current | | - | - | 50 | μΑ |
| T _{amb} = – | 40 °C to +125 °C | | | | | |
| V _{OH} | HIGH-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | |
| | = -40 °C to +125 °C HIGH-level output voltage | I_{O} = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V | $V_{CC} - 0.11$ | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.6 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 0.93 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.17 | - | - | V |
| | | $I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.77 | - | - | V |
| | | $I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.67 | - | - | V |
| | | $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | V | | | |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.30 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | 0.1 $0.3 \times V_{CC}$ 0.37 0.35 0.33 0.45 0.33 0.45 0.33 0.45 ± 0.5 ± 0.6 0.9 50 $ 0.11$ $0.33 \times V_{CC}$ 0.41 0.39 0.36 0.50 0.50 | |
| | | I_{O} = 20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.11 | V |
| | | $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.33 \times V_{CC}$ | V |
| | | $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.41 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.39 | V |
| | | $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.36 | V |
| | | $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.50 | V |
| | | $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 3.0 V | - | - | 0.50 | V |
| I | input leakage current | | - | - | ±0.75 | μΑ |
| I _{OFF} | power-off leakage current | $V_{\text{I}} \text{ or } V_{\text{O}}$ = 0 V to 3.6 V; V_{CC} = 0 V | - | - | ±0.75 | μA |

Low-power configurable multiple function gate

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|--------------------------------------|---|-----|-----|-------|------|
| ΔI_{OFF} | additional power-off leakage current | $ V_I \text{ or } V_O = 0 \text{ V to } 3.6 \text{ V}; $ | - | - | ±0.75 | μA |
| I _{CC} | supply current | $V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | - | - | 1.4 | μΑ |
| ΔI_{CC} | additional supply current | $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | - | - | 75 | μΑ |

Table 8. Static characteristics ...continued

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

| Symbol | Parameter | Conditions | | | 25 °C | | –40 °C to +125 °C | | | |
|-----------------------------------|--|--|-----|-----|----------------------|------|-------------------|----------------|-----------------|----|
| | | | | Min | Typ <mark>[1]</mark> | Max | Min | Max (85 °C) | Max (125 °C) | |
| C _L = 5 pl | F | | | | | | | | | |
| t _{pd} propagation delay | propagation delay | A, B and C to Y; see <u>Figure 12</u> | [2] | | | | | | | |
| | | $V_{CC} = 0.8 V$ | | - | 22.8 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 2.8 | 6.6 | 12.9 | 2.6 | 13.1 | 13.3 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 2.4 | 4.8 | 7.6 | 2.4 | 8.3 | 8.6 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 2.1 | 4.0 | 6.3 | 2.0 | 6.9 | 7.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.0 | 3.2 | 4.6 | 1.8 | 5.1 | 5.4 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 1.9 | 2.9 | 3.9 | 1.6 | 4.2 | 4.4 | ns |
| C _L = 10 | ρF | | | | | | | | | |
| t _{pd} propagation delay | A, B and C to Y; see <u>Figure 12</u> | [2] | | | | | | | | |
| | | $V_{CC} = 0.8 V$ | | - | 26.4 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 3.2 | 7.4 | 14.5 | 3.0 | 14.9 | 15.2 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 2.7 | 5.4 | 8.7 | 2.7 | 9.4 | 9.8 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 2.5 | 4.5 | 7.1 | 2.3 | 7.9 | 8.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.4 | 3.8 | 5.3 | 2.2 | 5.9 | 6.2 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 2.3 | 3.5 | 4.6 | 1.9 | 4.9 | 5.1 | ns |
| C _L = 15 | ρF | | | | | | | | | |
| t _{pd} | propagation delay | A, B and C to Y; see Figure 12 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 V$ | | - | 29.9 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 3.6 | 8.3 | 16.1 | 3.3 | 16.7 | 17.0 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 3.0 | 5.9 | 9.7 | 3.0 | 10.5 | 11.0 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 2.8 | 5.0 | 7.9 | 2.5 | 8.7 | 9.2 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.7 | 4.2 | 5.9 | 2.5 | 6.6 | 6.9 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 2.5 | 3.9 | 5.2 | 2.2 | 5.5 | 5.8 | ns |

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| Symbol | Parameter | Conditions | | 25 °C | | | -4 | Unit | | |
|----------------------|---------------------|---|--------|-------|--------|------|-----|----------------|-----------------|----|
| | | | | Min | Typ[1] | Мах | Min | Max (85 °C) | Max (125 °C) | _ |
| C _L = 30 | pF | | | | | | | | | |
| t _{pd} | propagation delay | A, B and C to Y; see <u>Figure 12</u> | [2] | | | | | | | |
| | | $V_{CC} = 0.8 V$ | | - | 38.0 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 4.5 | 10.5 | 20.8 | 4.1 | 21.9 | 24.1 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 3.8 | 7.5 | 12.2 | 3.8 | 13.5 | 14.1 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 3.4 | 6.3 | 10.0 | 3.1 | 11.2 | 11.9 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 3.4 | 5.3 | 7.5 | 3.1 | 8.4 | 8.9 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 3.3 | 5.0 | 6.6 | 2.9 | 7.1 | 7.4 | ns |
| C _L = 5 p | F, 10 pF, 15 pF and | 30 pF | | | | | | | | |
| C _{PD} | power dissipation | $f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{\text{CC}}$ | [3][4] | | | | | | | |
| | capacitance | $V_{CC} = 0.8 V$ | | - | 2.7 | - | - | - | - | pF |
| | | V_{CC} = 1.1 V to 1.3 V | | - | 2.8 | - | - | - | - | pF |
| | | V_{CC} = 1.4 V to 1.6 V | | - | 3.0 | - | - | - | - | pF |
| | | V_{CC} = 1.65 V to 1.95 V | | - | 3.2 | - | - | - | - | pF |
| | | V_{CC} = 2.3 V to 2.7 V | | - | 3.8 | - | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | | - | 4.4 | - | - | - | - | pF |

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 13</u>.

[1] All typical values are measured at nominal V_{CC} .

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] All specified values are the average typical values over all stated loads.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

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12. Waveforms

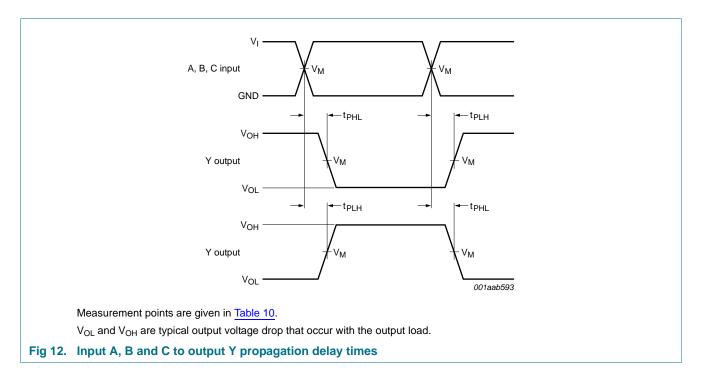


Table 10. Measurement points

| Supply voltage | Output | Input | | |
|-----------------|---------------------|---------------------|-----------------|---------------------------------|
| V _{CC} | V _M | V _M | VI | t _r = t _f |
| 0.8 V to 3.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{CC} | ≤ 3.0 ns |

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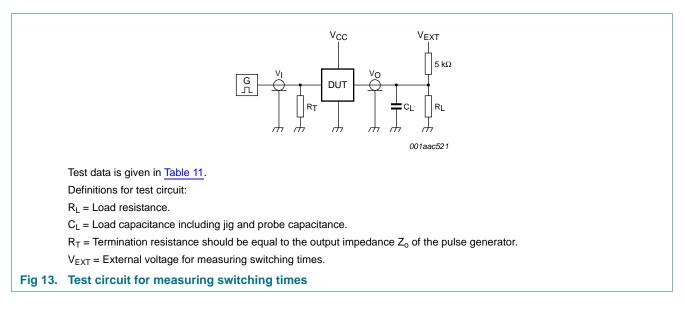


Table 11. Test data

| Supply voltage | Load | | V _{EXT} | | |
|-----------------|------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{cc} | CL | R _L [1] | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 k Ω or 1 M Ω | open | GND | $2 \times V_{CC}$ |

[1] For measuring enable and disable times $R_L = 5 k\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

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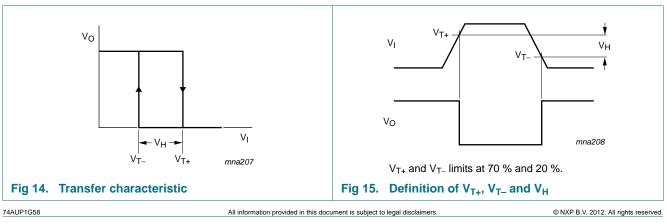
13. Transfer characteristics

Table 12. Transfer characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see Figure 13.

| Symbol | Parameter | Conditions | 25 °C | | | -40 | Unit | | |
|-----------------|-------------------------------------|---|-------|-----|------|------|----------------|-----------------|---|
| | | | Min | Тур | Мах | Min | Max (85 °C) | Max (125 °C) | _ |
| V_{T+} | positive-going threshold voltage | see <u>Figure 14</u> and Figure 15 | | | | | | | |
| | | $V_{CC} = 0.8 V$ | 0.30 | - | 0.60 | 0.30 | 0.60 | 0.62 | V |
| | | V _{CC} = 1.1 V | 0.53 | - | 0.90 | 0.53 | 0.90 | 0.92 | V |
| | | $V_{CC} = 1.4 V$ | 0.74 | - | 1.11 | 0.74 | 1.11 | 1.13 | V |
| | | V _{CC} = 1.65 V | 0.91 | - | 1.29 | 0.91 | 1.29 | 1.31 | V |
| | | $V_{CC} = 2.3 V$ | 1.37 | - | 1.77 | 1.37 | 1.77 | 1.80 | V |
| | | $V_{CC} = 3.0 V$ | 1.88 | - | 2.29 | 1.88 | 2.29 | 2.32 | V |
| V _{T-} | negative-going threshold voltage | see <u>Figure 14</u> and <u>Figure 15</u> | | | | | | | |
| | | $V_{CC} = 0.8 V$ | 0.10 | - | 0.60 | 0.10 | 0.60 | 0.60 | V |
| | | V _{CC} = 1.1 V | 0.26 | - | 0.65 | 0.26 | 0.65 | 0.65 | V |
| | | $V_{CC} = 1.4 V$ | 0.39 | - | 0.75 | 0.39 | 0.75 | 0.75 | V |
| | | V _{CC} = 1.65 V | 0.47 | - | 0.84 | 0.47 | 0.84 | 0.84 | V |
| | | $V_{CC} = 2.3 V$ | 0.69 | - | 1.04 | 0.69 | 1.04 | 1.04 | V |
| | | $V_{CC} = 3.0 V$ | 0.88 | - | 1.24 | 0.88 | 1.24 | 1.24 | V |
| V _H | hysteresis voltage | (V _{T+} – V _{T-}); see <u>Figure 14,</u> <u>Figure 15,</u> <u>Figure 16</u> and <u>Figure 17</u> | | | | | | | |
| | | $V_{CC} = 0.8 V$ | 0.07 | - | 0.50 | 0.07 | 0.50 | 0.50 | V |
| | | V _{CC} = 1.1 V | 0.08 | - | 0.46 | 0.08 | 0.46 | 0.46 | V |
| | | V _{CC} = 1.4 V | 0.18 | - | 0.56 | 0.18 | 0.56 | 0.56 | V |
| | | V _{CC} = 1.65 V | 0.27 | - | 0.66 | 0.27 | 0.66 | 0.66 | V |
| | | $V_{CC} = 2.3 V$ | 0.53 | - | 0.92 | 0.53 | 0.92 | 0.92 | V |
| | | $V_{CC} = 3.0 V$ | 0.79 | - | 1.31 | 0.79 | 1.31 | 1.31 | V |

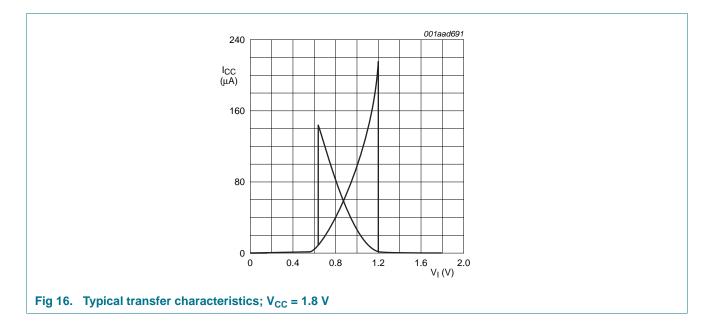
14. Waveforms transfer characteristics

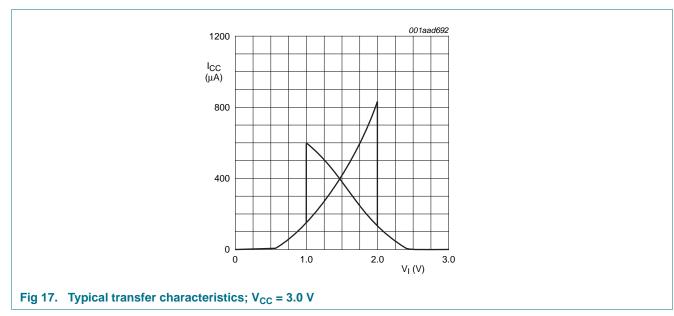


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15. Package outline

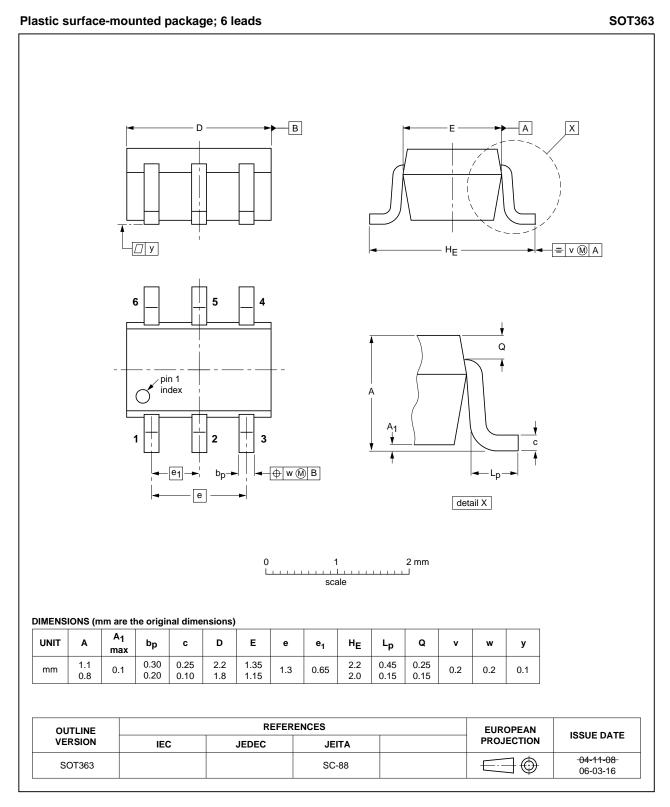


Fig 18. Package outline SOT363 (SC-88)

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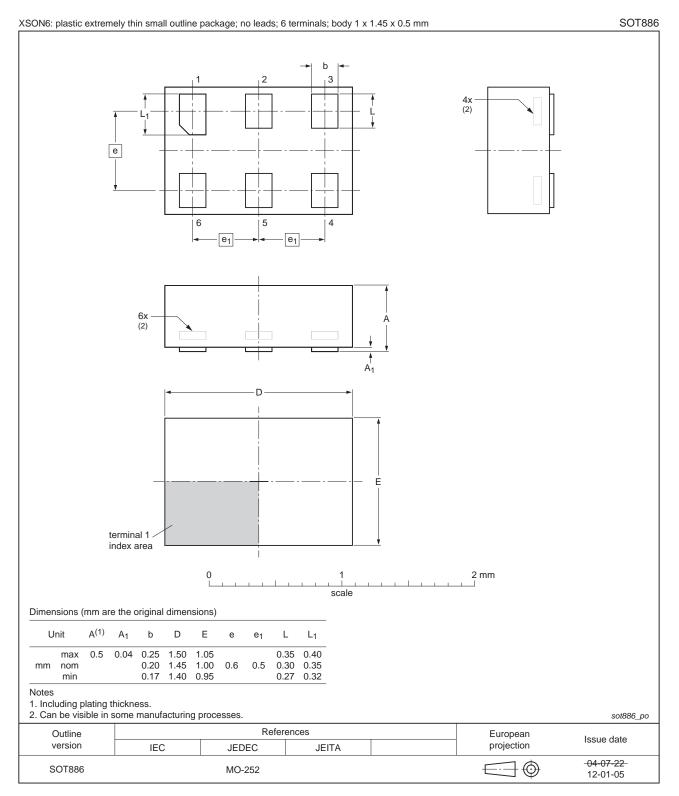


Fig 19. Package outline SOT886 (XSON6)

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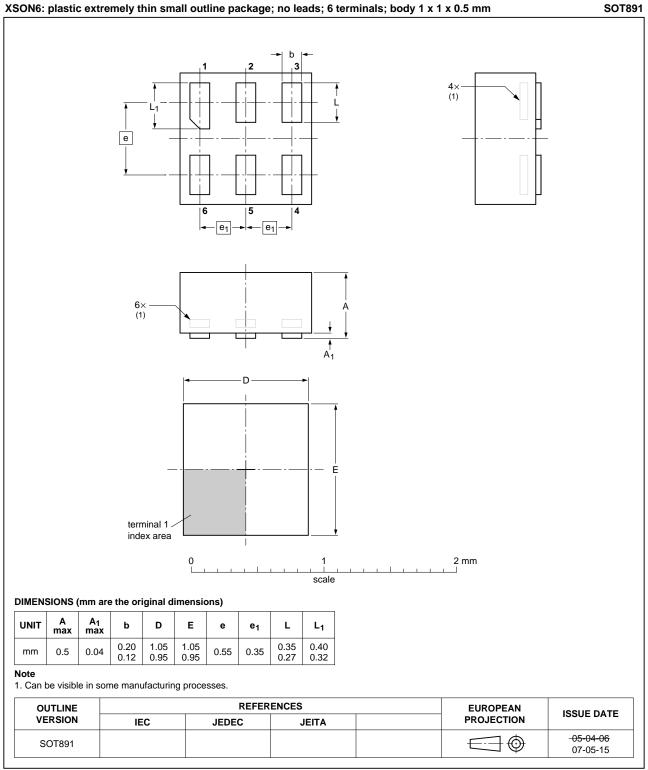
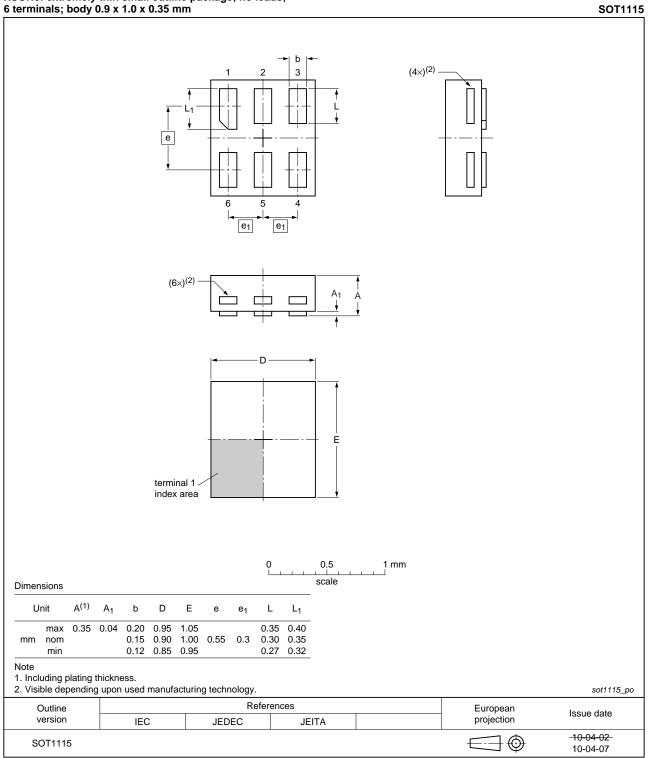


Fig 20. Package outline SOT891 (XSON6)

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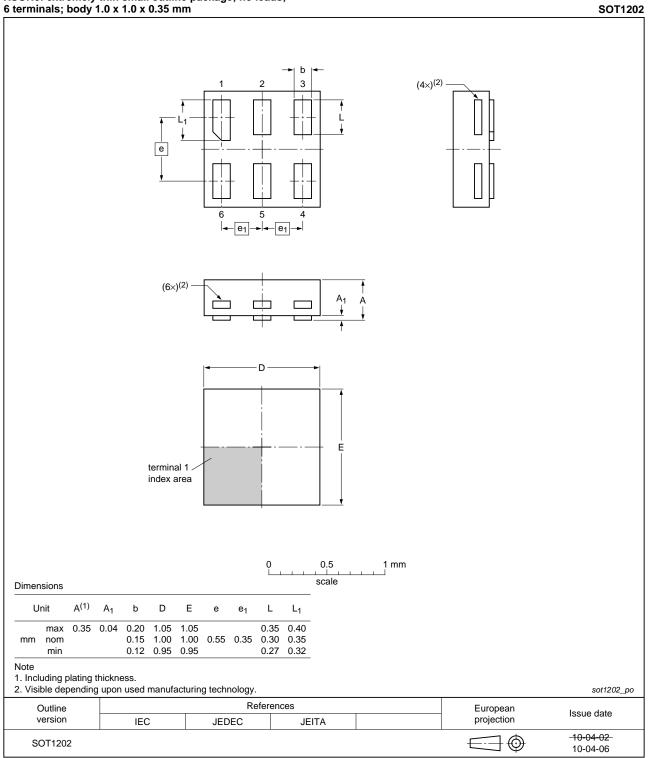


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 21. Package outline SOT1115 (XSON6)

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XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 22. Package outline SOT1202 (XSON6)

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|-----------------|-------------|------|----------|----|---------|----|-------|----------|-----|
| | | | | | | | | | |

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16. Abbreviations

| Acronym CDM DUT | Description Charged Device Model |
|-----------------------|----------------------------------|
| | - |
| | |
| DOT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |

17. Revision history

Table 14. Revision history **Document ID Release date** Data sheet status **Change notice** Supersedes 74AUP1G58 v.6 20120815 Product data sheet 74AUP1G58 v.5 Modifications: Package outline drawing of SOT886 (Figure 19) modified. 74AUP1G58 v.5 20111129 Product data sheet 74AUP1G58 v.4 -74AUP1G58 v.4 20101011 Product data sheet 74AUP1G58 v.3 -74AUP1G58 v.3 20090622 Product data sheet 74AUP1G58 v.2 -74AUP1G58 v.2 20090326 Product data sheet 74AUP1G58 v.1 -74AUP1G58 v.1 20070131 Product data sheet _ -

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|--------------------------------|-------------------------------|---|
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[1] Please consult the most recently issued document before initiating or completing a design.

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